

# AR4029

## 200 TO 4000 MHz TO-8B CASCADABLE AMPLIFIER

Typical Values	AR4029
Low Noise Figure .....	<2.5 dB
High Output Power .....	+26.0 dBm
High Performance Thin Film TO-8B Package	

### SPECIFICATIONS\*

Parameter	Typical	Guaranteed	
		0 to 50 °C	-55 to +85 °C
Frequency (Min.)	100-4200 MHz	200-4000 MHz	200-4000 MHz
Small Signal Gain (Min.)	22.0 dB	20.5 dB	20.0 dB
Gain Flatness (Max.)	±0.6 dB	±0.8 dB	±1.0 dB
Noise Figure (Max.)	<2.5 dB	3.0 dB	3.5 dB
SWR (Max.) Input/Output	1.7:1	1.9:1	2.0:1
Power Output (Min.) @ 1dB comp.	+26.0 <sup>^</sup> dBm	+25.0 <sup>^</sup> dBm	+24.5 <sup>^</sup> dBm
DC Current (Max.)	188 mA	200 mA	220 mA

\* Measured in a 50-ohm system at +15 Vdc unless otherwise specified.  
<sup>^</sup> 3.0 dB lower above 3500 MHz.

### INTERMODULATION PERFORMANCE

Typical @ 1GHz	AR4029
Second Order Harmonic Intercept Point .....	+59 dBm
Second Order Two Tone Intercept Point .....	+53 dBm
Third Order Two Tone Intercept Point .....	+38 dBm

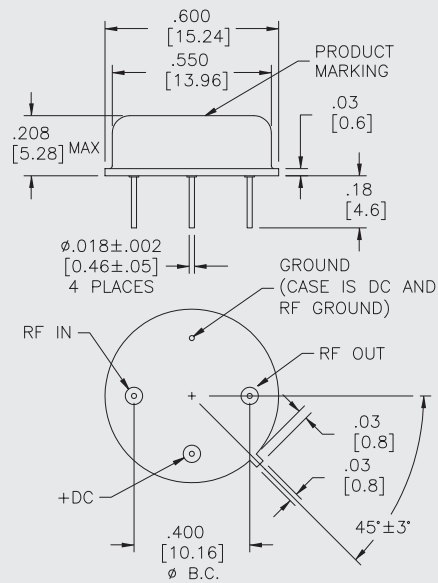
### ABSOLUTE MAXIMUM RATINGS

Storage Temperature .....	-62 to +125 °C
Maximum Case Temperature .....	+110 °C
Maximum DC Voltage .....	+17 Volts
Maximum Continuous RF Input Power .....	+11 dBm
Maximum Short Term Input Power (1 Minute Max.) .....	+15 dBm
Maximum Peak Power (3 μsec Max.) .....	+18 dBm
Burn-in Temperature .....	+85 °C
Thermal Resistance <sup>1</sup> (θjc) .....	12 °C/Watt
Junction Temperature Rise Above Case (Tjc) .....	33.2 °C

<sup>1</sup> Thermal resistance is based on total power dissipation.

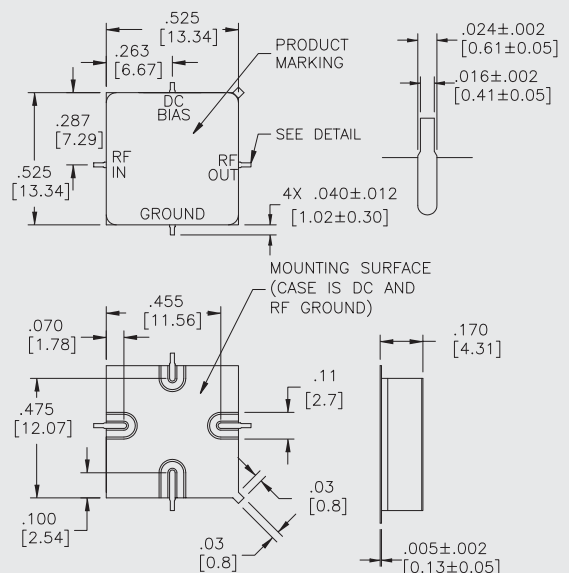
### AR4029

#### TO-8B Package for Amplifiers



### ARS4029

#### SMT0-8B Package for Amplifiers



DIMENSIONS ARE IN INCHES [MILLIMETERS]